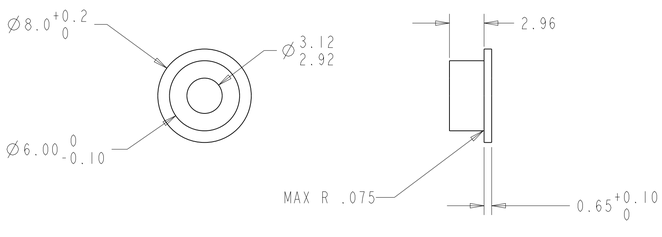
DWG. NO.	SIZE	REV.	SH.
21F3601		1	1



REV	DWG	CHK	DATE	CHANGES

UNLESS OTHERWISE SPECIFIED
DIM X.X ±0.1 FRAC ±1/64
DIM X.XX ±0.03 Angles ±1 DEG
DIM X.XXX ±0.010 FINISH 32 RMS

DO NOT SCALE PRINT

TAPERS ARE CLOSE 2
CHAMFER ENDS OF ALL SCREW TAPERS 45°
CUT ROUND, 1/8 THRUS RELIEF ON MACHINED THREADED BREAK EDGES, DEB MAX. ON MACHINED WORK
REMOVE BURRS, MELD SPATTER & LOOSE SCALE
(IN ACCORDANCE WITH ASME Y14.5M & ENG.)

SHOP ORDERS

MATL	SEE J.O	HT TREAT	
PLATE	J.O WIDTH		
FINISH	CHEMICAL CHROMIC ETCH		
MARKING	TAG		
PROJECT	ATL-IP-ED-0030		
PROJECT NAME	US ATLAS SILICON SUBSYSTEM		
DRAWN BY	D UHEN	DATE	18-Feb-10
CHK BY	J WIRTH	DATE	18-FEB-10
APP BY	E ANDERSEN	DATE	

DESCRIPTION: VICTREX PEEK
MATERIAL

ERNEST ORLANDO LAWRENCE BERKELEY NATIONAL LABORATORY
UNIVERSITY OF CALIFORNIA - BERKELEY

ATLAS PIXEL DETECTOR
DISK SECTOR, MODULE LOCAL SUPPORT
T-WASHER, SECTOR MOUNT

MICROFILMED: | DWG. TYPE: PART | DRAWN ON: 21F-350 | SCALE: 4.000 | DO NOT SCALE PRINT
PATENT CLEAR: | DESIGN ACCT. NO.: ON J.O. | CATEGORY CODE: AP6110 | DWG. NO.: 21F3601 | SIZE: | REV.: 1
SHEET 1 OF 1

Jobs_21F4_OCEAN_MODULE_OCEAN